

IRG4BC10UDPbF

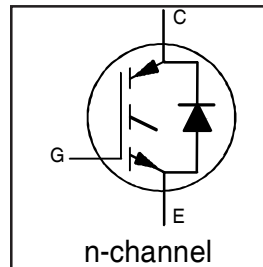
INSULATED GATE BIPOLAR TRANSISTOR WITH ULTRAFast SOFT RECOVERY DIODE UltraFast CoPack IGBT

Features

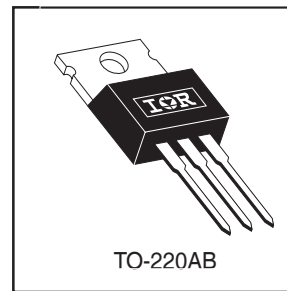
- UltraFast: Optimized for high operating up to 80 kHz in hard switching, >200 kHz in resonant mode
- Generation 4 IGBT design provides tighter parameter distribution and higher efficiency than previous Generation
- IGBT co-packaged with HEXFRED™ ultrafast, ultra-soft-recovery anti-parallel diodes for use in bridge configurations
- Industry standard TO-220AB package
- Lead-Free

Benefits

- Generation 4 IGBT's offer highest efficiencies available
- IGBT's optimized for specific application conditions
- HEXFRED diodes optimized for performance with IGBT's . Minimized recovery characteristics require less/no snubbing



| |
|------------------------------|
| $V_{CES} = 600V$ |
| $V_{CE(on) typ.} = 2.15V$ |
| @ $V_{GE} = 15V, I_C = 5.0A$ |
| $t_f (typ.) = 140ns$ |



Absolute Maximum Ratings

| | Parameter | Max. | Units |
|---------------------------|------------------------------------|-----------------------------------|-------|
| V_{CES} | Collector-to-Emitter Voltage | 600 | V |
| $I_C @ T_C = 25^\circ C$ | Continuous Collector Current | 8.5 | A |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current | 5.0 | |
| I_{CM} | Pulsed Collector Current ① | 34 | |
| I_{LM} | Clamped Inductive Load Current ② | 34 | |
| $I_F @ T_C = 100^\circ C$ | Diode Continuous Forward Current | 4.0 | |
| I_{FM} | Diode Maximum Forward Current | 16 | |
| V_{GE} | Gate-to-Emitter Voltage | ± 20 | V |
| $P_D @ T_C = 25^\circ C$ | Maximum Power Dissipation | 38 | W |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation | 15 | |
| T_J | Operating Junction and | -55 to +150 | °C |
| T_{STG} | Storage Temperature Range | | |
| | Soldering Temperature, for 10 sec. | 300 (0.063 in. (1.6mm) from case) | |
| | Mounting Torque, 6-32 or M3 Screw. | 10 lbf•in (1.1 N•m) | |

Thermal Resistance

| | Parameter | Min. | Typ. | Max. | Units |
|-----------------|---|------|----------|------|--------|
| $R_{\theta JC}$ | Junction-to-Case - IGBT | — | — | 3.3 | °C/W |
| $R_{\theta JC}$ | Junction-to-Case - Diode | — | — | 7.0 | |
| $R_{\theta CS}$ | Case-to-Sink, flat, greased surface | — | 0.50 | — | |
| $R_{\theta JA}$ | Junction-to-Ambient, typical socket mount | — | — | 80 | |
| Wt | Weight | — | 2 (0.07) | — | g (oz) |

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Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Conditions | |
|---------------------------------|---|------|------|-----------|----------------------|---|---|
| $V_{(BR)CES}$ | Collector-to-Emitter Breakdown Voltage ^③ | 600 | — | — | V | $V_{GE} = 0V, I_C = 250\mu A$ | |
| $\Delta V_{(BR)CES}/\Delta T_J$ | Temperature Coeff. of Breakdown Voltage | — | 0.54 | — | V/ $^\circ\text{C}$ | $V_{GE} = 0V, I_C = 1.0mA$ | |
| $V_{CE(on)}$ | Collector-to-Emitter Saturation Voltage | — | 2.15 | 2.6 | V | $V_{GE} = 15V$ See Fig. 2, 5 | |
| | | — | 2.61 | — | | | $I_C = 5.0A$ |
| | | — | 2.30 | — | | | $I_C = 8.5A$ $I_C = 5.0A, T_J = 150^\circ\text{C}$ |
| $V_{GE(th)}$ | Gate Threshold Voltage | 3.0 | — | 6.0 | | $V_{CE} = V_{GE}, I_C = 250\mu A$ | |
| $\Delta V_{GE(th)}/\Delta T_J$ | Temperature Coeff. of Threshold Voltage | — | -8.7 | — | mV/ $^\circ\text{C}$ | $V_{CE} = V_{GE}, I_C = 250\mu A$ | |
| g_{fe} | Forward Transconductance ^④ | 2.8 | 4.2 | — | S | $V_{CE} = 100V, I_C = 5.0A$ | |
| I_{CES} | Zero Gate Voltage Collector Current | — | — | 250 | μA | $V_{GE} = 0V, V_{CE} = 600V$ | |
| | | — | — | 1000 | | $V_{GE} = 0V, V_{CE} = 600V, T_J = 150^\circ\text{C}$ | |
| V_{FM} | Diode Forward Voltage Drop | — | 1.5 | 1.8 | V | $I_C = 4.0A$ See Fig. 13 | |
| | | — | 1.4 | 1.7 | | | $I_C = 4.0A, T_J = 125^\circ\text{C}$ |
| I_{GES} | Gate-to-Emitter Leakage Current | — | — | ± 100 | nA | $V_{GE} = \pm 20V$ | |

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|------------------|--|------|------|------|------------|--|
| Q_g | Total Gate Charge (turn-on) | — | 15 | 22 | nC | $I_C = 5.0A$ $V_{CC} = 400V$ See Fig. 8 $V_{GE} = 15V$ |
| Q_{ge} | Gate - Emitter Charge (turn-on) | — | 2.6 | 4.0 | | |
| Q_{gc} | Gate - Collector Charge (turn-on) | — | 5.8 | 8.7 | | |
| $t_{d(on)}$ | Turn-On Delay Time | — | 40 | — | ns | $T_J = 25^\circ\text{C}$ $I_C = 5.0A, V_{CC} = 480V$ $V_{GE} = 15V, R_G = 100\Omega$ Energy losses include "tail" and diode reverse recovery. See Fig. 9, 10, 18 |
| t_r | Rise Time | — | 16 | — | | |
| $t_{d(off)}$ | Turn-Off Delay Time | — | 87 | 130 | | |
| t_f | Fall Time | — | 140 | 210 | | |
| E_{on} | Turn-On Switching Loss | — | 0.14 | — | | |
| E_{off} | Turn-Off Switching Loss | — | 0.12 | — | mJ | |
| E_{ts} | Total Switching Loss | — | 0.26 | 0.33 | | |
| $t_{d(on)}$ | Turn-On Delay Time | — | 38 | — | ns | $T_J = 150^\circ\text{C}$, See Fig. 11, 18 $I_C = 5.0A, V_{CC} = 480V$ $V_{GE} = 15V, R_G = 100\Omega$ Energy losses include "tail" and diode reverse recovery. |
| t_r | Rise Time | — | 18 | — | | |
| $t_{d(off)}$ | Turn-Off Delay Time | — | 95 | — | | |
| t_f | Fall Time | — | 250 | — | | |
| E_{ts} | Total Switching Loss | — | 0.45 | — | | |
| L_E | Internal Emitter Inductance | — | 7.5 | — | nH | Measured 5mm from package |
| C_{ies} | Input Capacitance | — | 270 | — | pF | $V_{GE} = 0V$ $V_{CC} = 30V$ See Fig. 7 $f = 1.0MHz$ |
| C_{oes} | Output Capacitance | — | 21 | — | | |
| C_{res} | Reverse Transfer Capacitance | — | 3.5 | — | | |
| t_{rr} | Diode Reverse Recovery Time | — | 28 | 42 | ns | $T_J = 25^\circ\text{C}$ See Fig. 14 $T_J = 125^\circ\text{C}$ |
| | | — | 38 | 57 | | |
| I_{rr} | Diode Peak Reverse Recovery Current | — | 2.9 | 5.2 | A | $T_J = 25^\circ\text{C}$ See Fig. 15 $T_J = 125^\circ\text{C}$ |
| | | — | 3.7 | 6.7 | | |
| Q_{rr} | Diode Reverse Recovery Charge | — | 40 | 60 | nC | $T_J = 25^\circ\text{C}$ See Fig. 16 $T_J = 125^\circ\text{C}$ |
| | | — | 70 | 105 | | |
| $di_{(rec)M}/dt$ | Diode Peak Rate of Fall of Recovery During t_b | — | 280 | — | A/ μs | $T_J = 25^\circ\text{C}$ See Fig. 17 $T_J = 125^\circ\text{C}$ |
| | | — | 235 | — | | |

Details of note ① through ④ are on the last page

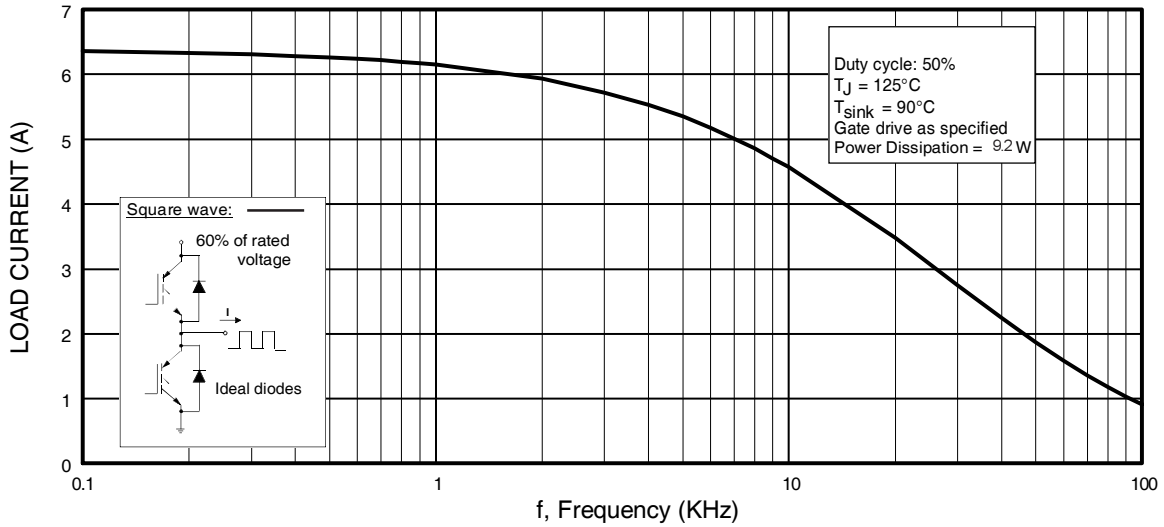


Fig. 1 - Typical Load Current vs. Frequency
 (Load Current = I_{RMS} of fundamental)

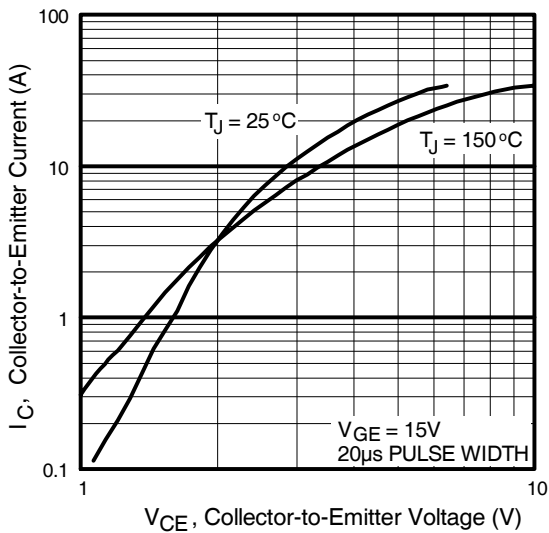


Fig. 2 - Typical Output Characteristics
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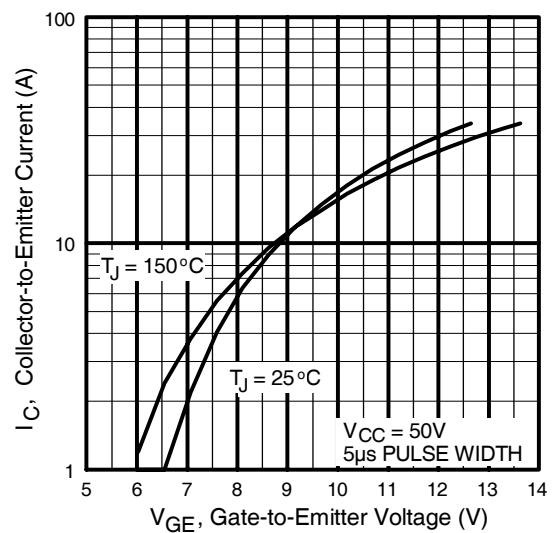


Fig. 3 - Typical Transfer Characteristics

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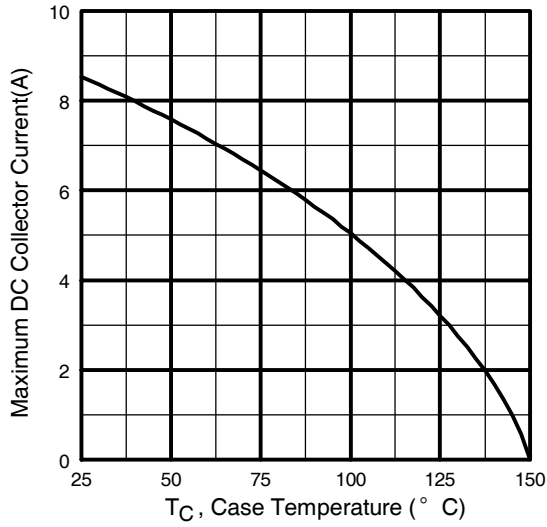


Fig. 4 - Maximum Collector Current vs. Case Temperature

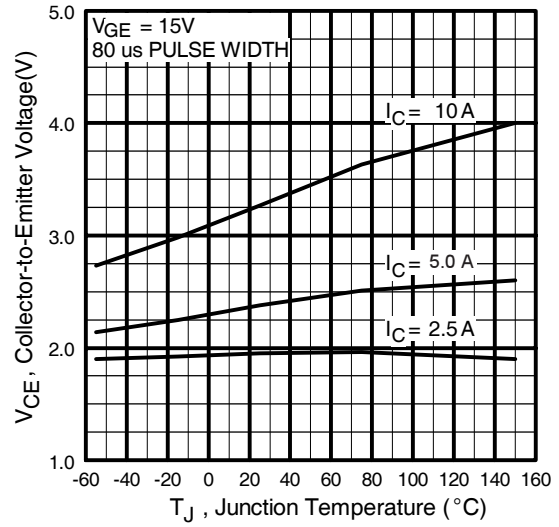


Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature

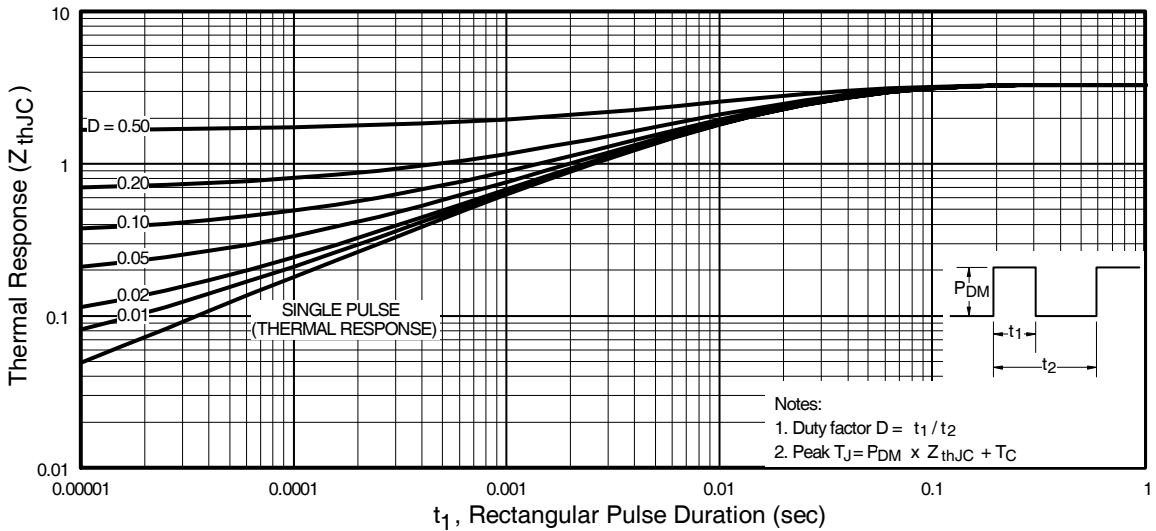


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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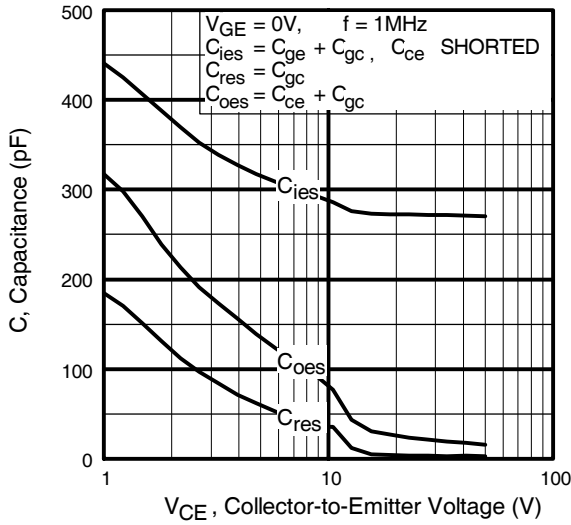


Fig. 7 - Typical Capacitance vs. Collector-to-Emitter Voltage

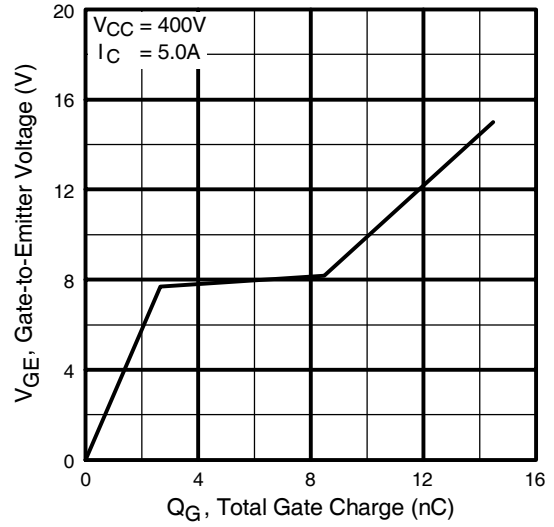


Fig. 8 - Typical Gate Charge vs. Gate-to-Emitter Voltage

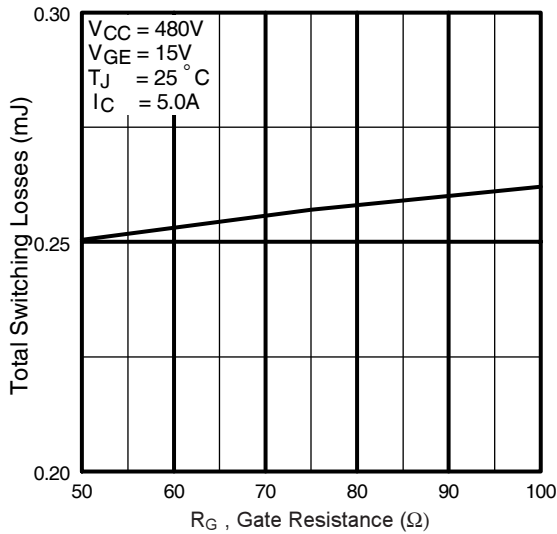


Fig. 9 - Typical Switching Losses vs. Gate Resistance

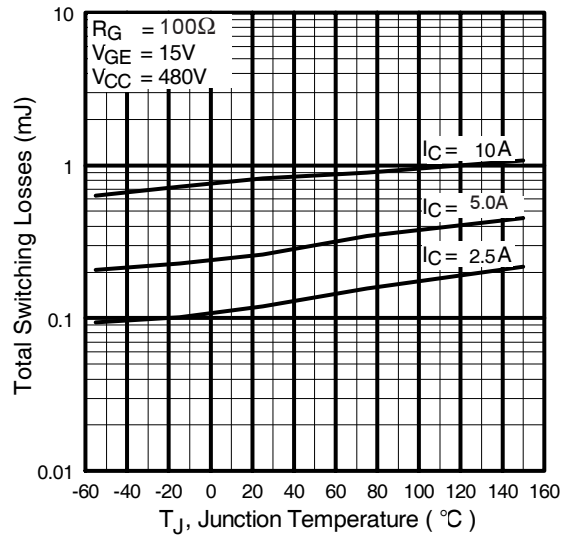


Fig. 10 - Typical Switching Losses vs. Junction Temperature

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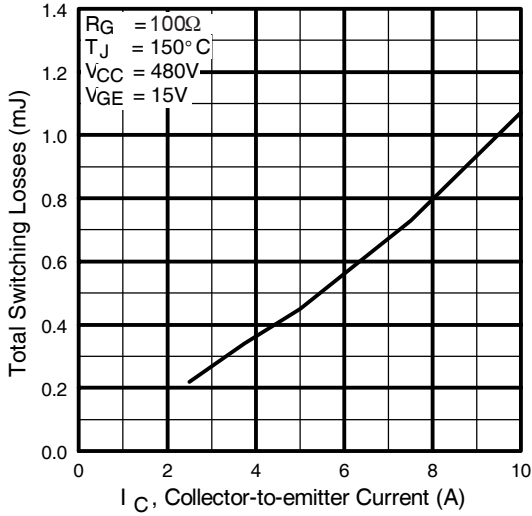


Fig. 11 - Typical Switching Losses vs. Collector-to-Emitter Current

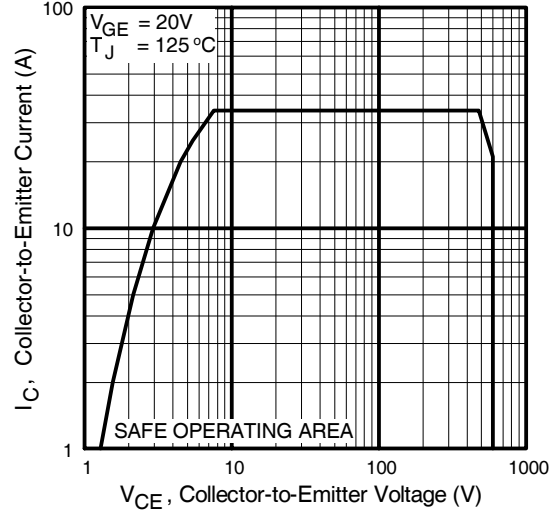


Fig. 12 - Turn-Off SOA

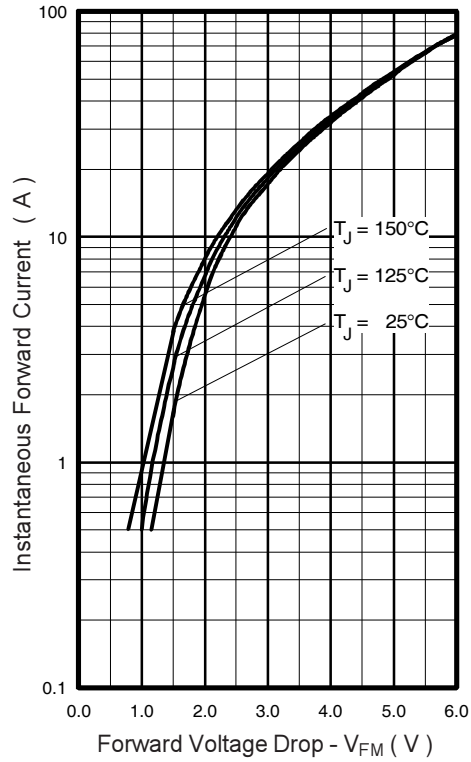


Fig. 13 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

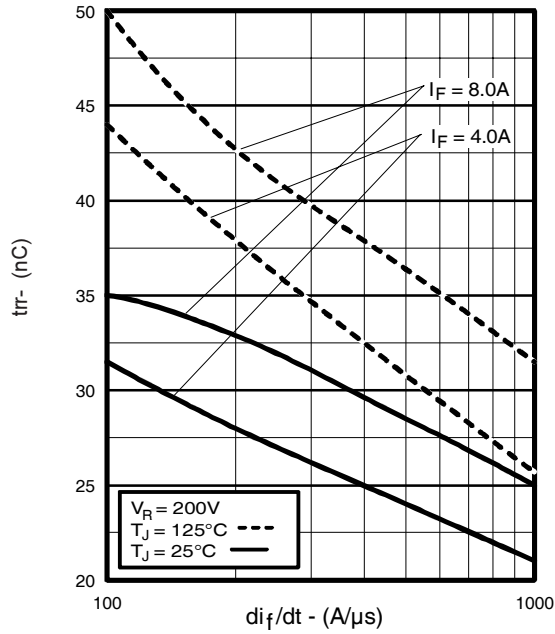


Fig. 14 - Typical Reverse Recovery vs. di_f/dt

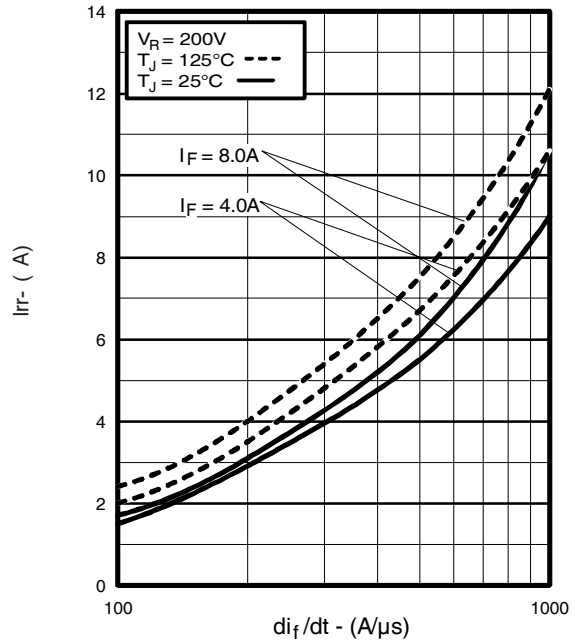


Fig. 15 - Typical Recovery Current vs. di_f/dt

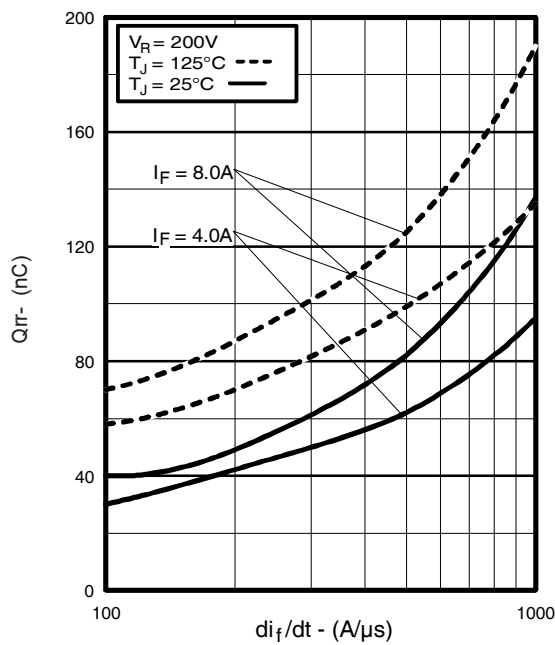


Fig. 16 - Typical Stored Charge vs. di_f/dt

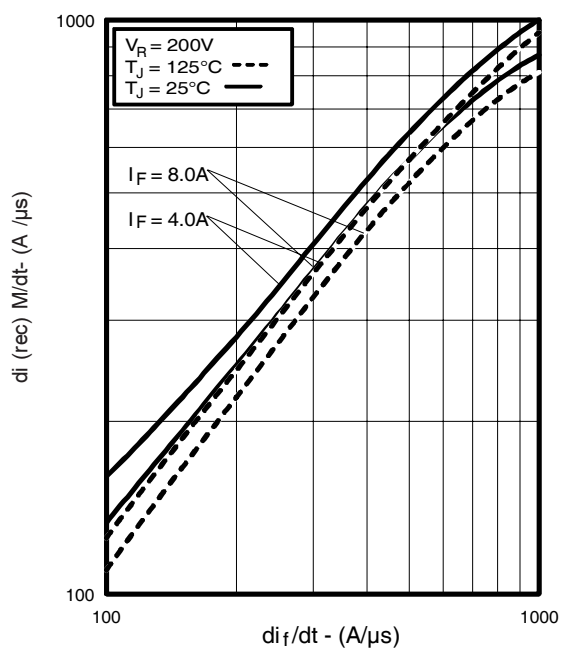


Fig. 17 - Typical $di_{(rec)M}/dt$ vs. di_f/dt

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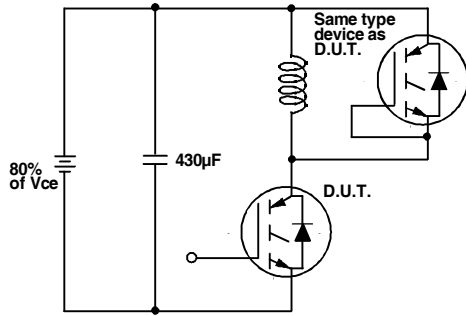


Fig. 18a - Test Circuit for Measurement of I_{LM} , E_{on} , $E_{off}(\text{diode})$, t_{rr} , Q_{rr} , I_{rr} , $t_{d(on)}$, t_r , $t_{d(off)}$, t_f

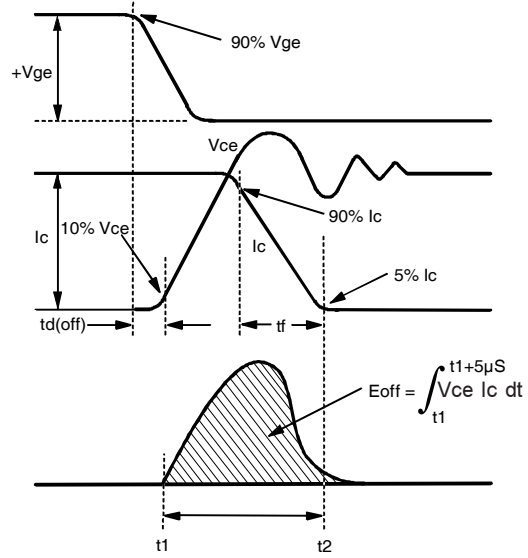


Fig. 18b - Test Waveforms for Circuit of Fig. 18a, Defining E_{off} , $t_{d(off)}$, t_f

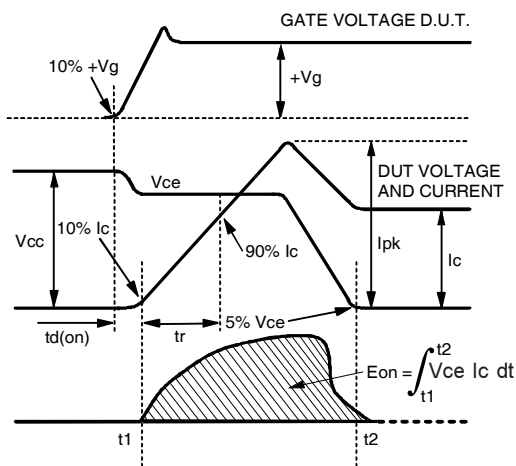


Fig. 18c - Test Waveforms for Circuit of Fig. 18a, Defining E_{on} , $t_{d(on)}$, t_r

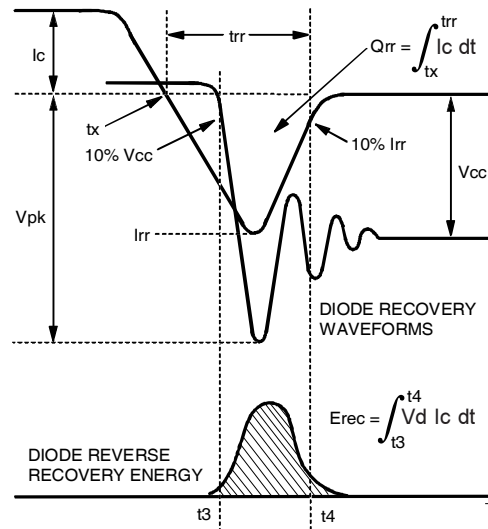


Fig. 18d - Test Waveforms for Circuit of Fig. 18a, Defining E_{rec} , t_{rr} , Q_{rr} , I_{rr}

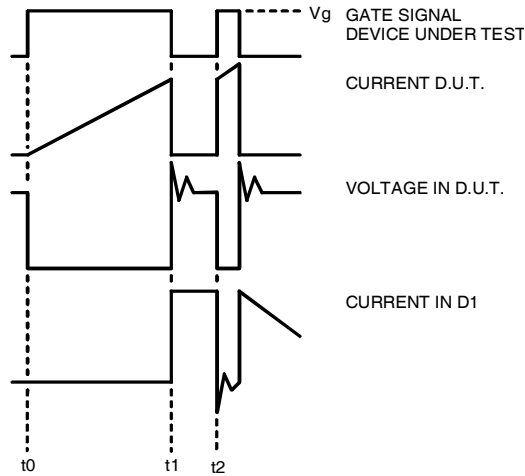


Figure 18e. Macro Waveforms for Figure 18a's Test Circuit

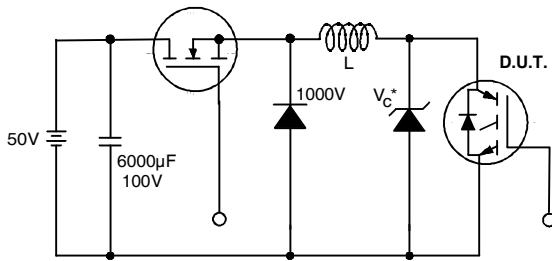


Figure 19. Clamped Inductive Load Test Circuit

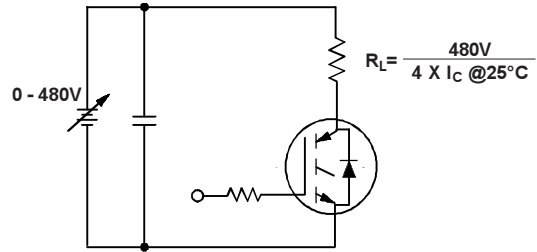


Figure 20. Pulsed Collector Current Test Circuit

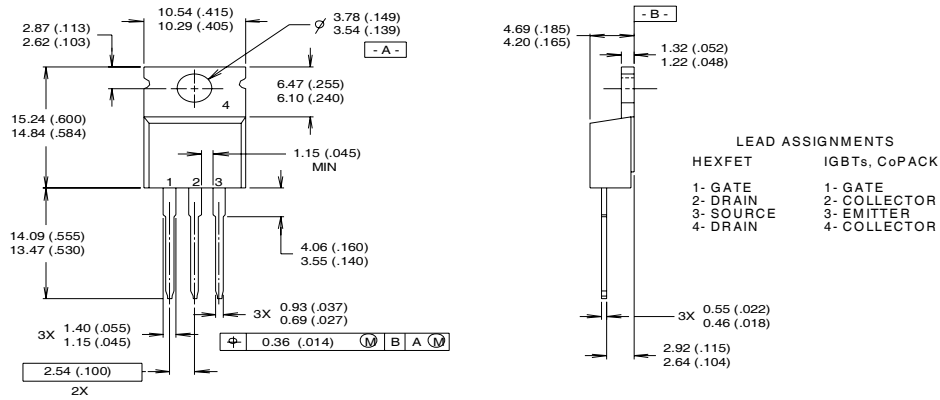
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Notes:

- ① Repetitive rating: $V_{GE}=20V$; pulse width limited by maximum junction temperature (figure 20)
- ② $V_{CC}=80\%(V_{CES})$, $V_{GE}=20V$, $L=10\mu H$, $R_G = 100\Omega$ (figure 19)
- ③ Pulse width $\leq 80\mu s$; duty factor $\leq 0.1\%$.
- ④ Pulse width $5.0\mu s$, single shot.

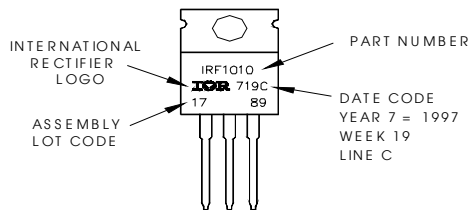
TO-220AB Package Outline



- NOTES:
- 1 DIMENSIONING & TOLERANCING PER ANSI Y14.5M, 1982.
 - 2 CONTROLLING DIMENSION : INCH
 - 3 OUTLINE CONFORMS TO JEDEC OUTLINE TO-220AB.
 - 4 HEATSINK & LEAD MEASUREMENTS DO NOT INCLUDE BURRS.

TO-220AB Part Marking Information

EXAMPLE: THIS IS AN IRF1010
 LOT CODE 1789
 ASSEMBLED ON WW 19, 1997
 IN THE ASSEMBLY LINE "C"
Note: "P" in assembly line
 position indicates "Lead-Free"



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Note: For the most current drawings please refer to the IR website at:
<http://www.irf.com/package/>

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[GT50JR22\(STA1ES\)](#) [TIG058E8-TL-H](#) [IGW40N120H3FKSA1](#) [VS-CPV364M4KPBF](#) [NGTB25N120FL2WAG](#) [NGTG40N120FL2WG](#)
[RJH60F3DPQ-A0#T0](#) [APT40GR120B2SCD10](#) [APT15GT120BRG](#) [APT20GT60BRG](#) [NGTB75N65FL2WAG](#) [NGTG15N120FL2WG](#)
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[APT35GP120JDQ2](#) [XD15H120CX1](#) [XD25H120CX0](#) [XP15PJS120CL1B1](#) [IGW30N60H3FKSA1](#) [STGWA8M120DF3](#) [IGW08T120FKSA1](#)
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[RJH60D2DPP-M0#T2](#) [IKP20N60TXKSA1](#) [IHW20N65R5XKSA1](#) [APT70GR120JD60](#) [AOD5B60D](#) [APT70GR120L](#) [STGWT60H65FB](#)
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